

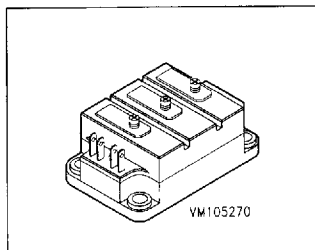
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T-23-09

IGBT Module
Preliminary Data**BSM 100 GB 120 D**
BSM 100 GAL 120 D $V_{CE} = 1200 \text{ V}$ $I_C = 2 \times 135 \text{ A at } T_C = 25^\circ\text{C}$ $I_C = 2 \times 100 \text{ A at } T_C = 80^\circ\text{C}$

- Power module
- Half-bridge/Chopper
- Including fast free-wheel diodes
- Package with insulated metal base plate
- Package outlines/Circuit diagram: 5a, 5b¹⁾



Half-bridge		Chopper	
Type	Ordering Code	Type	Ordering Code
BSM 100 GB 120 D	C67076-A2107-A2	BSM 100 GAL 120 D	C67076-A2012-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector-emitter voltage	V_{CE}	1200	V
Collector-gate voltage, $R_{GE} = 20 \text{ k}\Omega$	V_{CGR}	1200	
Gate-emitter voltage	V_{GE}	± 20	
Continuous collector current, $T_C = 25^\circ\text{C}$ $T_C = 80^\circ\text{C}$	I_C	135 100	A
Pulsed collector current, $T_C = 25^\circ\text{C}$ $T_C = 80^\circ\text{C}$	$I_{C \text{ puls}}$	270 200	
Operating and storage temperature range	T_j, T_{stg}	$-55 \dots +150$	$^\circ\text{C}$
Power dissipation, $T_C = 25^\circ\text{C}$	P_{tot}	1000	W
Thermal resistance, chip-case	R_{thJC}	≤ 0.13	K/W
Insulation test voltage ²⁾ , $t = 1 \text{ min.}$	V_{is}	2500	V _{ac}
Creepage distance	—	16	mm
Clearance	—	11	
DIN humidity category, DIN 40 040	—	F	—
IEC climatic category, DIN IEC 68-1	—	55/150/56	

¹⁾ See chapter Package Outline and Circuit Diagrams.²⁾ Insulation test voltage between collector and metal base plate referred to standard climate 23/50 in acc. with DIN 50 014, IEC 146, para. 492.1.

SIEMENS**BSM 100 GB 120 D**
BSM 100 GAL 120 D**SIEMENS AKTIENGESELLSCHAFT****Electrical Characteristics**at $T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Collector-emitter breakdown voltage $V_{GE} = 0, I_C = 2\text{ mA}$	$V_{(BR)CES}$	1200	—	—	V
Gate threshold voltage $V_{GE} = V_{CE}, I_C = 8\text{ mA}$	$V_{GE(th)}$	4.8	5.5	6.2	
Collector-emitter saturation voltage $V_{GE} = 15\text{ V}, I_C = 100\text{ A}$ $T_j = 25\text{ }^{\circ}\text{C}$ $T_j = 150\text{ }^{\circ}\text{C}$	$V_{CE(sat)}$	— —	2.8 4.0	3.3 4.5	
Zero gate voltage collector current $V_{CE} = 1200\text{ V}, V_{GE} = 0$ $T_j = 25\text{ }^{\circ}\text{C}$ $T_j = 125\text{ }^{\circ}\text{C}$	I_{CES}	— —	— —	2000 —	μA
Gate-emitter leakage current $V_{GE} = 20\text{ V}, V_{CE} = 0$	I_{GES}	—	—	100	nA

AC Characteristics

Forward transconductance $V_{GE} = 20\text{ V}, I_C = 100\text{ A}$	g_{fs}	36	—	—	S
Input capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0, f = 1\text{ MHz}$	C_{iss}	—	16000	—	pF
Output capacitance, $V_{GS} = 0$ $V_{CE} = 25\text{ V}, V_{GE} = 0, f = 1\text{ MHz}$	C_{oss}	—	1300	—	
Reverse transfer capacitance $V_{CE} = 25\text{ V}, V_{GE} = 0, f = 1\text{ MHz}$	C_{rss}	—	500	—	

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Switching Characteristics

at $T_j = 125\text{ }^{\circ}\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Resistive Load

Turn-on delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	$t_{d(on)}$	100	180	220	ns
Rise time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	t_r	—	450	—	
Turn-off delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	$t_{d(off)}$	—	550	—	
Fall time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	t_f	—	500	—	

Inductive Load

Turn-on delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	$t_{d(on)}$	100	180	220	ns
Rise time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	t_r	28	56	85	
Turn-off delay time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	$t_{d(off)}$	410	550	660	
Fall time $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	t_f	60	85	110	
Turn-off loss ($E_{off} = E_{off1} + E_{off2}$) $V_{CC} = 600\text{ V}$, $V_{GE} = 15\text{ V}$, $I_C = 100\text{ A}$ $R_{g(on)} = 3.3\text{ }\Omega$, $R_{g(off)} = 3.3\text{ }\Omega$	E_{off1} E_{off2}	— —	6 5	— —	mWs

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Electrical Characteristics

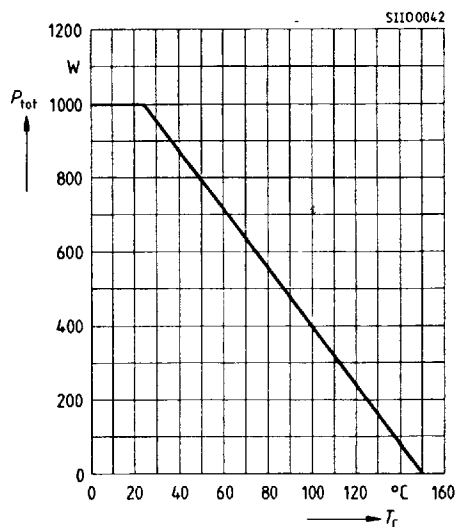
at $T_J = 25\text{ °C}$, unless otherwise specified.

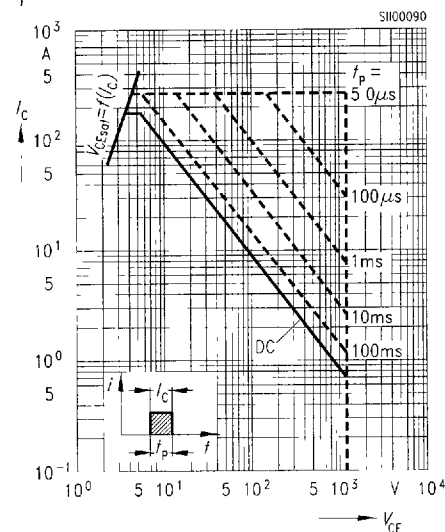
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

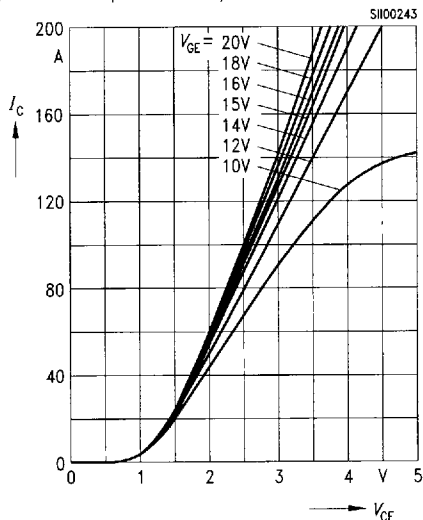
Free-Wheel Diode

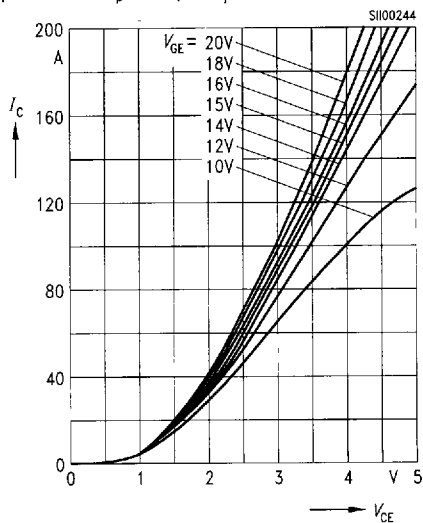
Diode forward voltage $I_F = 100\text{ A}$, $V_{GE} = 0$ $T_J = 25\text{ °C}$ $T_J = 125\text{ °C}$	V_F	— —	2.45 1.9	— —	V
Reverse recovery time $I_F = 100\text{ A}$, $V_R = 600\text{ V}$ $V_{GE} = 0$, $di_F/dt = -1500\text{ A/}\mu\text{s}$ $T_J = 125\text{ °C}$	t_{rr}	—	0.3	—	μs
Reverse recovery charge $I_F = 100\text{ A}$, $V_R = 600\text{ V}$ $V_{GE} = 0$, $di_F/dt = -1500\text{ A/}\mu\text{s}$ $T_J = 25\text{ °C}$ $T_J = 125\text{ °C}$	Q_{rr}	— —	6 18	— —	μC
Soft factor $I_F = 100\text{ A}$, $V_R = 600\text{ V}$ $V_{GE} = 0$, $di_F/dt = -1500\text{ A/}\mu\text{s}$ $T_J = 125\text{ °C}$	S	—	1	—	—
Thermal resistance Chip-case	R_{thJC}	—	—	0.5	K/W

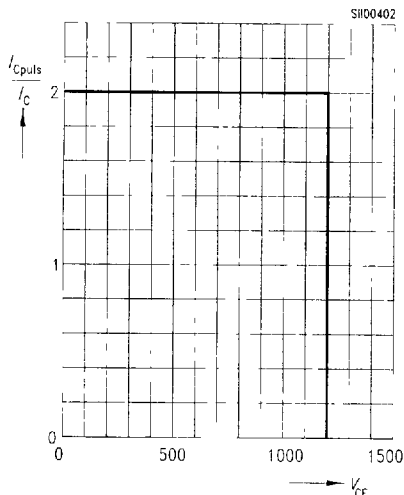
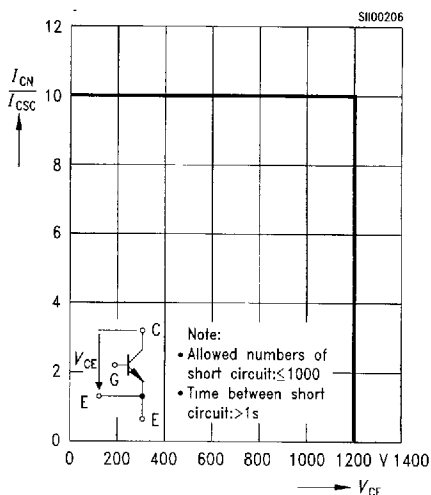
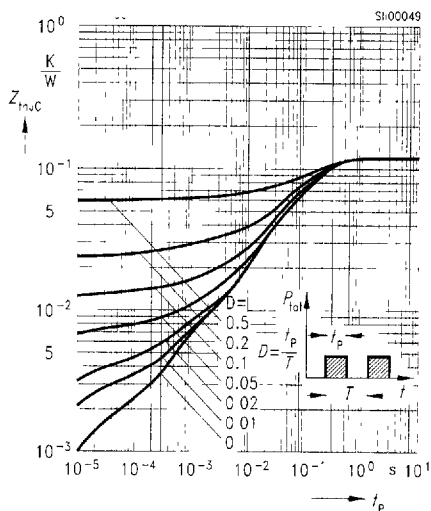
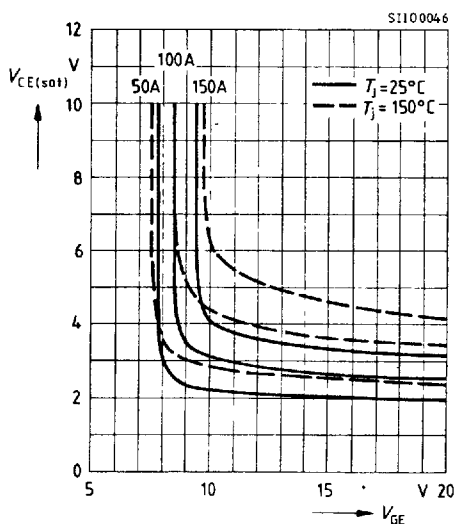
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Characteristics at $T_j = 25^\circ\text{C}$, unless otherwise specified.
Power dissipation $P_{\text{tot}} = f(T_C)$

parameter: $T_j = 150^\circ\text{C}$

Safe operating area $I_C = f(V_{CE})$

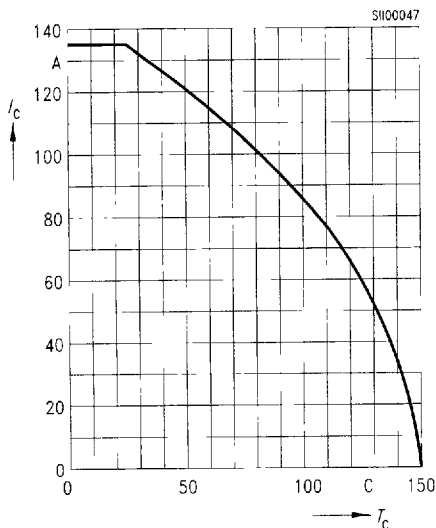
parameter: single pulse, $T_C = 25^\circ\text{C}$
 $T_j = 150^\circ\text{C}$

Typ. output characteristics $I_C = f(V_{CE})$

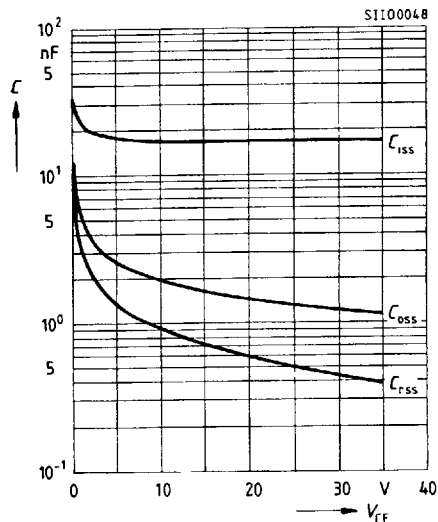
parameter: $t_p = 80 \mu\text{s}$, $T_j \leq 25^\circ\text{C}$

Typ. output characteristics $I_C = f(V_{CE})$

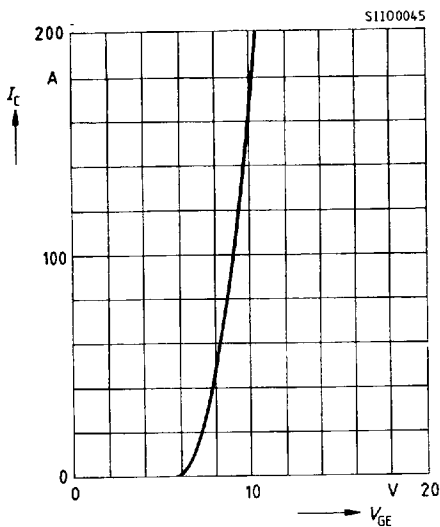
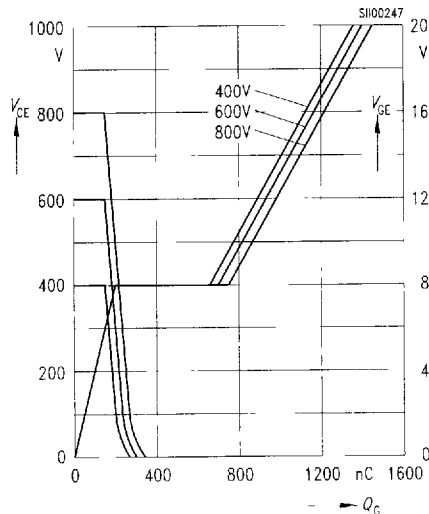
parameter: $t_p = 80 \mu\text{s}$, $T_j \leq 125^\circ\text{C}$


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Reverse biased safe operating area
 $I_C = f(V_{CE})$, parameter: $T_J = 125^\circ\text{C}$,
 $V_{GE} = 15\text{ V}$, $R_{g(\text{off})} = 3.3\ \Omega$,
 L (parasitic inductance, module) $< 50\text{ nH}$

Safe operating area,
short circuit $I_C = f(V_{CE})$, $V_{GE} = \pm 15\text{ V}$
 $T_J \leq 150^\circ\text{C}$, $t_{SC} \leq 10\ \mu\text{s}$, $L < 50\text{ nH}$

Transient thermal impedance
 $Z_{thJC} = f(t_p)$, parameter: $D = t_p / T$

Typ. on-state characteristics
 $V_{CE(\text{sat})} = f(V_{GE})$, parameter: I_C , T_J


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Collector current $I_C = f(T_C)$

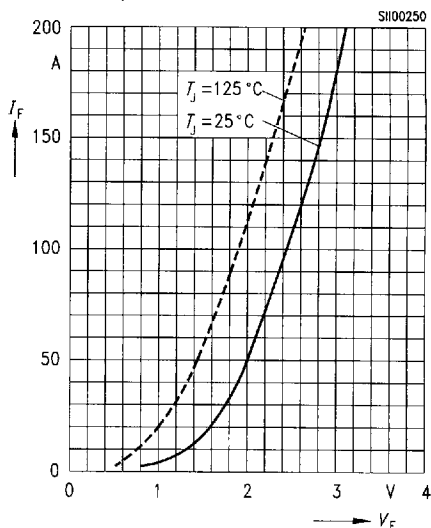
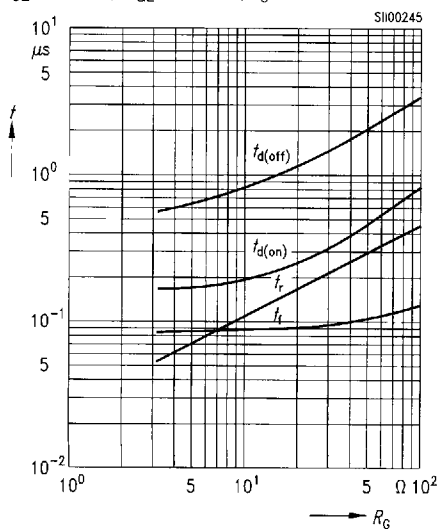
parameter: $V_{GE} \geq 15 \text{ V}$, $T_J = 150^\circ \text{C}$

Typ. capacitances $C = f(V_{CE})$

parameter: $V_{GE} = 0$, $f = 1 \text{ MHz}$

Typ. transfer characteristics $I_C = f(V_{GE})$

parameter: $t_p = 80 \mu\text{s}$, $V_{CE} = 20 \text{ V}$

Typ. gate charge $V_{CE}, V_{GE} = f(Q_G)$


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**Forward characteristics of
fast recovery reverse diode** $I_F = f(V_F)$
parameter: T_j **Typ. switching time** $t = f(R_G)$ Inductive load, parameter: $T_j = 125\text{ °C}$ $V_{CE} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $I_C = 100\text{ A}$ **Typ. switching time** $t = f(I_C)$ Inductive load, parameter: $T_j = 125\text{ °C}$ $V_{CE} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$, $R_G = 5.6\text{ Ω}$ 